New Development of Compute Node based on xTCA

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Outline

- Development for PXD
 - New computer Node
 - Carrier Board progress
 - AMC card progress
- AMC development for SVD DATCON
 - Requirement
 - status
- Summary

Development for PXD (1)

- New Compute Node
 - Carrier Board Board
 of ATCA size (8U
 high), complaint to
 xTCA
 - One V4 FPGA on
 Carrier Board for
 stwitching
 - 4 AMC cards with
 V5(w PPC,70t)



Development for PXD (2)

- Status of Carrier Board(Carrier + Power + Case)
 - Carrier Board Board soldered Nov. 2011
 - Power Board solder in Jan. 2012
 - Testing both in Giessen and IHEP
 - Power card OK at Giessen(soldering problem found at IHEP)
 - Function test under going





Development for PXD (3)

- AMC (xFP) card
 - xFP 1.0 with 50T FPGA tested OK at IHEP Aug. 2011
 - xFP 1.0 with 70T FPGA(w PPC) tested at JLUG Oct.
 2011
 - Main problems found
 - DDR2RW speed low
 - Pin assignment error
 - Single DDR2 test(50t/70t)



DDR2	clock	R/W speed	DDR2	Clock	R/W speed	
DDR2_A	200M	400MHz	DDR2_A	167M	334MHz	
DDR2_B	167M	334MHz	DDR2_B	167M	334MHz	

Double DDR2 joint test(50t/70t)

DDR2	clock	R/W speed	DDR2	clock	R/W speed
DDR2_A_B	167M	334MHz	DDR2_A_B	167M	334MHz

Development for PXD (4) xFP1.0 Upgrade to xPF 2.0

xFP V1.0 function list

- SFP 6Gb/FPGA (2x3Gb/s)
- 2xDDR2 4GB (2x2GB)
- 2xFlash (512Mbit)
- No Platform Flash
- 1x Gbit Ethernet
- 1x UART
- IPMC/MMC

xFP V2.0 changes

- 1x Platform Flash
- Pin assignment change
- New DDR2 routing
- Power supply device

Upgrade :

- 1. Platform Flash : self-configuration when power on
- 2. Power supply: enhanced the supplying current.
- 3. DDR2 Routing: better spped hopefully

Development for PXD (5)

- Staus of AMC (xFP) card
 - xPF 2.0 come back with Key Components soldered yesterday
 - Problem found
 - Wrong direction of DDR2 sockets
- Plan
 - Has been sent back to factory, come back next week
 - Start testing when back next week



Development for SVD DATCON (1)

- Requirement from Jochen, Carlos and Michael
 - 2 types of AMCs
 - 50t FPGA, 2 GB RAM, and 4 SFP connectors
 - 110t FPGA, 4 GB RAM, 1 RJ45/PHY and 2 SFP connector
 - Carrier boards
- Plan
 - New design with 4 SFP
 - Share AMC PCB with PXD for 2 SFP
 - Share Carier with PXD

Development for SVD DATCON (2)

- Status
 - AMC with 4 SFP with help of company
 - New connector decided
 - Design finished
 - Layout finished
 - PCB produced
 - Expeced next week
 - AMC with 2 SFP



- To be soldered after PXD test successful
- Carrier boards waiting for PXD test result
- Plan
 - Bonn U. test in March with AMC if basically OK

summary

- CN Development for PXD
 - Carrier Board is slow but smoothly
 - AMC is in good shape
 - Soldering problem lost a week
- CN development for SVD DATCON
 - Well planned after detailed discussion
 - Now key problem foreseen now
 - AMC with 4 SFP almost in hand
- Development smoothly in General, by mid of this year, new system be used for functioning test from user, if not satisfactory in March

Thank you for your attention !